TQP369185

DC-6 GHz Gain Block

Applications

- Mobile Infrastructure
- LTE / WCDMA / CDMA
- CATV
- Point to Point
- General Purpose Wireless

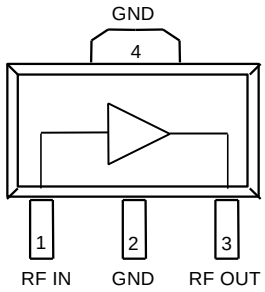


SOT-89 Package

Product Features

- Cascadable Gain Block
- DC – 6000 MHz
- 19 dB Gain at 1.9 GHz
- 4.7 dB Noise Figure at 1.9 GHz
- +31.7 dBm Output IP3
- +19.6 dBm P1dB
- Internally matched to 50 Ohms
- Internal active bias
- Robust Class 2 (>2000V) HBM ESD Rating

Functional Block Diagram



General Description

The TQP369185 is a general-purpose buffer amplifier that offers high dynamic range in a low-cost surface-mount package. At 1.9 GHz, the amplifier typically provides 19 dB gain, +31.7 dBm OIP3, and 4.6 dB Noise Figure while drawing 75 mA current. The device combines dependable performance with consistent quality to maintain MTTF values exceeding 100 years at mounting temperatures of +85°C. The device is housed in a lead-free/green/RoHS-compliant industry-standard SOT-89 package.

The TQP369185 consists of a Darlington-pair amplifier using TriQuint's high reliability InGaP/GaAs HBT process technology. Internal active bias enables operation with only DC-blocking capacitors and an RF choke on the DC bias feed. This broadband MMIC amplifier can be directly applied to various current and next generation wireless technologies such as CDMA, W-CDMA, and LTE. In addition, the TQP369185 will work for other various applications within the DC to 6 GHz frequency range.

Pin Configuration

Pin #	Symbol
1	RF IN
3	RF OUT
2, 4	GND

Ordering Information

Part No.	Description
TQP369185	InGaP/GaAs HBT Gain Block
TQP369185-PCB	0.5-4 GHz Evaluation Board

Standard T/R size = 2500 pieces on a 13" reel

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Specifications

Absolute Maximum Ratings

Parameter	Rating
Storage Temperature	-55 to 150 °C
RF Input Power,CW,50 Ω,T=25ºC	25dBm
Device Voltage, V_{CC}	7.0V

Operation of this device outside the parameter ranges given above may cause permanent damage.

Recommended Operating Conditions

Parameter	Min	Typ	Max	Units
V_{CC}	+4.75	+5	+5.25	V
Tcase	-40		+85	°C
Tj (for>10^6 hours MTTF)			+170	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

Test conditions unless otherwise noted: +25ºC, Vcc=+5V, 50 Ω system

Parameter	Conditions	Min	Typical	Max	Units
Operational Frequency Range		DC		6000	MHz
Test Frequency			1900		MHz
Gain		17.5	19	20.5	dB
Input Return Loss			-13.5		dB
Output Return Loss			-9.6		dB
Output P1dB			+19.6		dBm
Output IP3	See Note 1.	+28	+31.7		dBm
Noise Figure			4.6		dB
Device Voltage, V_{CC}			5		V
Device Current, I_{CC}		55	75	92	mA
Thermal Resistance (jnc to case) θ_{jc}				82	°C/W

Notes:
1. OIP3 is measured with two tones at an output power of -3 dBm / tone separated by 1 MHz. The suppression on the largest IM3 product is used to calculate the OIP3 using 2:1 rule. 2:1 rule gives relative value with respect to fundamental tone.

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Device Characterization Data

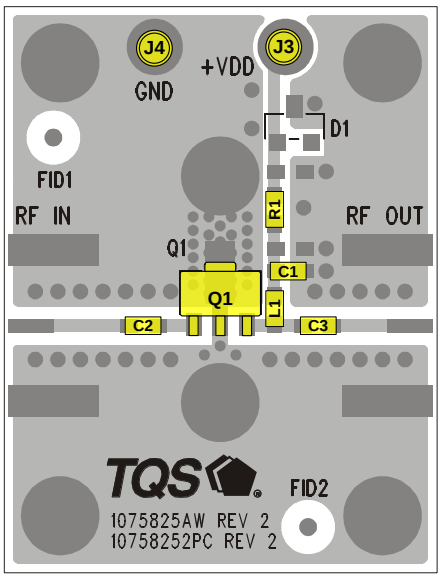
S-Parameter Data

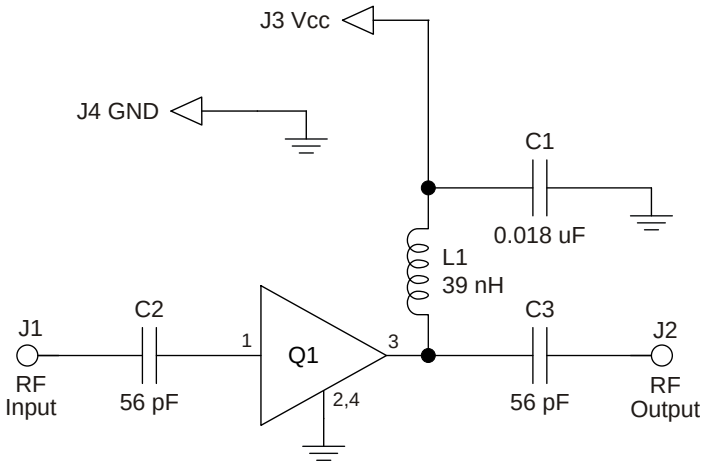
V_{CC} = 5.0 V, I_{CC} = 72 mA, T_{case} = +25°C, unmatched 50 ohm system, calibrated to device leads

Freq (MHz)	S11 (dB)	S11 (ang)	S21 (dB)	S21 (ang)	S12 (dB)	S12 (ang)	S22 (dB)	S22 (ang)
10	-19.3	-178.5	21.3	179.4	-26.2	0.5	-14.3	3.2
20	-19.0	-177.3	21.4	178.6	-26.1	0.5	-14.0	1.0
50	-18.6	-175.6	21.4	177.6	-26.0	-0.4	-14.3	-2.7
100	-18.4	-176.9	21.3	174.5	-26.1	-0.3	-14.4	-8.5
200	-17.9	-170.6	21.3	169.7	-26.1	-0.6	-14.0	-16.2
500	-16.9	-169.8	21.0	155.4	-26.0	-2.7	-13.4	-43.7
1000	-14.3	-173.6	20.5	132.9	-25.6	-6.1	-12.0	-83.8
1500	-12.3	178.7	20.0	110.6	-25.1	-10.7	-10.4	-119.2
2000	-10.7	163.5	19.3	89.1	-24.5	-18.4	-8.9	-149.9
2500	-9.1	148.7	18.5	68.1	-24.2	-26.3	-7.9	-177.8
3000	-7.8	136.2	17.7	49.2	-23.8	-34.8	-7.0	160.8
3500	-6.9	125.7	16.8	30.8	-23.5	-44.4	-6.3	141.0
4000	-6.5	115.7	15.8	12.5	-23.5	-53.7	-5.3	122.0
4500	-6.7	101.4	14.7	-4.6	-23.7	-62.5	-5.0	104.1
5000	-5.8	89.6	13.7	-19.6	-23.5	-69.4	-4.7	90.3
5500	-4.8	80.2	13.1	-36.1	-23.5	-79.2	-4.1	78.6
6000	-4.3	69.8	12.1	-52.3	-23.7	-89.4	-4.0	66.0

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Application Circuit Configuration





Notes:
1. See PC Board Layout, under Application Information section, for more information.
2. All components are of 0603 size unless otherwise stated.
3. Zero Ohm resistor R1 is used to bridge a trace gap on PCB 1075825 and is not required in end user applications.

Bill of Material: TQP369185-PCB

Reference Des.	Value	Description	Manufacturer	Part Number
Q1	n/a	Gain Block	TriQuint	TQP369185
C1	0.018 uF	Cap, Chip, 0603, 16V, X7R, 10%	various	
C2, C3	56 pF	Cap, Chip, 0603, 50V, NPO, 5%	various	
L1	39 nH	Inductor, 0603, 5%, CS Series	Coilcraft	
R1	0 Ohm	Res, Chip, 603, 1/10W, 5%	various	

Component Values for Specific Frequencies

Use the component values in this table for optimal operation at specific frequencies.

Reference Designator	Frequency (MHz)						
	50	500	900	1900	2200	2500	3500
L1	820 nH	220 nH	68 nH	27 nH	22 nH	18 nH	15 nH
C2, C3	.018 uF	1000 pF	100 pF	68 pF	68 pF	56 pF	39 pF

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Typical Performance

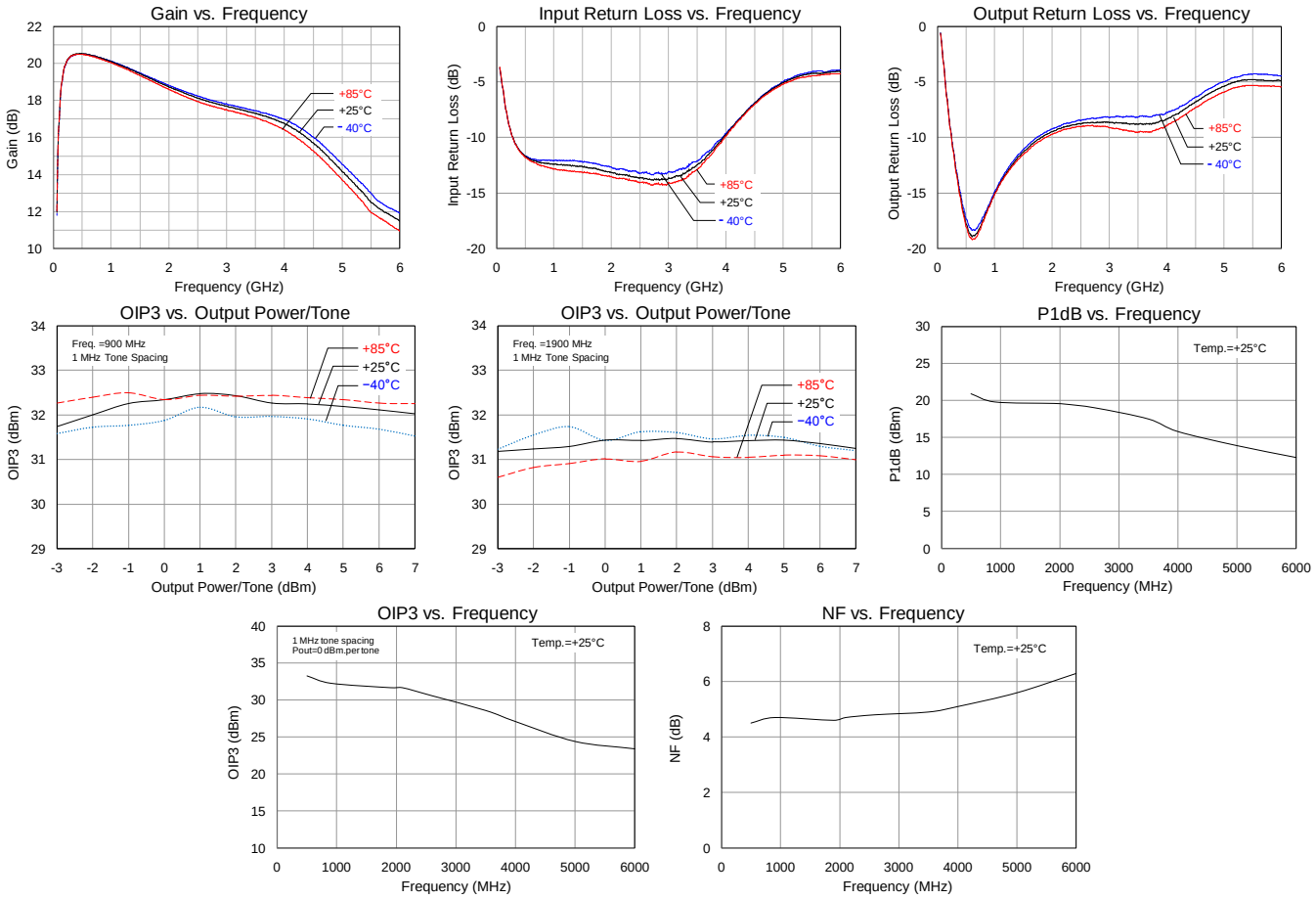
Test conditions unless otherwise noted: V_{CC} = 5 V, I_{CC} = 75 mA, T_{case} = +25°C

Frequency	MHz	500	900	1900	2100	2600	3500	4000	5000	6000
Gain	dB	20.5	20.4	19.0	18.6	18.0	16.8	15.8	13.7	12.1
Input Return Loss	dB	11.7	12.4	12.3	13.3	13.7	-6.9	-6.5	-5.8	-4.3
Output Return Loss	dB	17.8	15.9	10	9.3	8.7	-6.3	-5.3	-4.7	-4
Output P1dB	dBm	20.9	+19.8	+19.6	+19.5	+19	+17.5	+15.8	+13.9	+12.3
OIP3 [1]	dBm	+33.3	+32.3	+31.7	+31.7	+30.6	+28.6	+27.1	+24.4	+23.4
Noise Figure	dB	4.5	4.7	4.6	4.7	4.8	4.9	5.1	5.6	6.3

Notes:
1. OIP3 measured with two tones at an output power of -3 dBm / tone separated by 1 MHz. The suppression on the largest IM3 product is used to calculate the OIP3 using 2:1 rule.
2. Measured on TQP369185-PCB

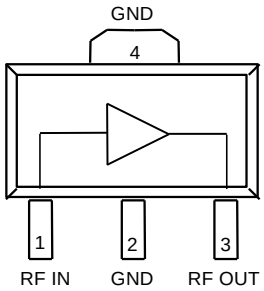
Performance Plots

Test conditions unless otherwise noted: V_{CC} = 5 V, I_{CC} = 75 mA, TQP369185-PCB



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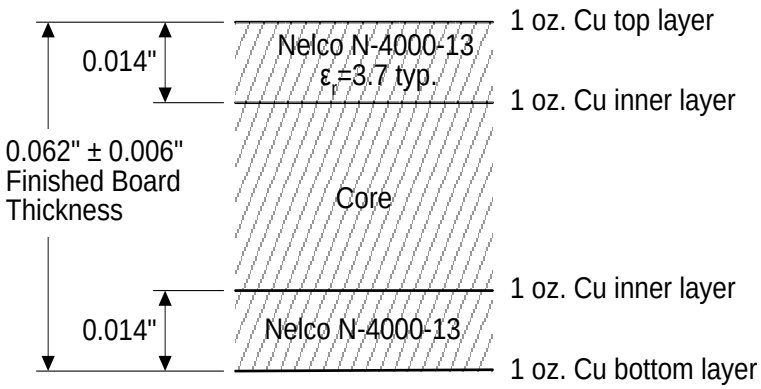
Pin Description

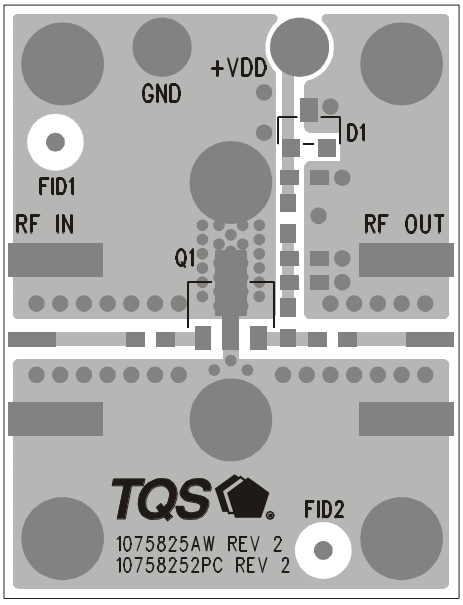


Pin	Symbol	Description
1	RF IN	RF input, matched to 50 ohms. External DC Block is required.
3	RF OUT	RF output / DC supply, matched to 50 ohms. External DC Block and bias choke are required.
2, 4	GND Paddle	Backside Paddle. Multiple vias should be employed to minimize inductance and thermal resistance; see page 7 for mounting configuration.

Evaluation Board PCB Specifications

Material Stack-Up and Layout



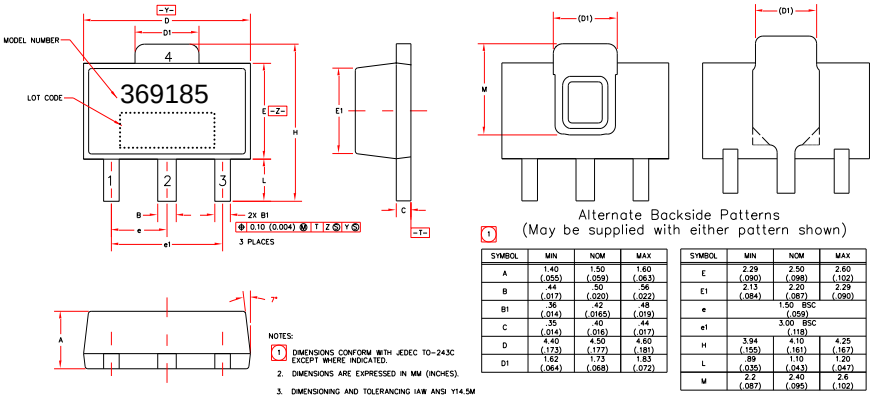


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Mechanical Information

Package Marking and Dimensions

The component will be marked on the top surface of package with a "369185" designator and an alphanumeric lot code.

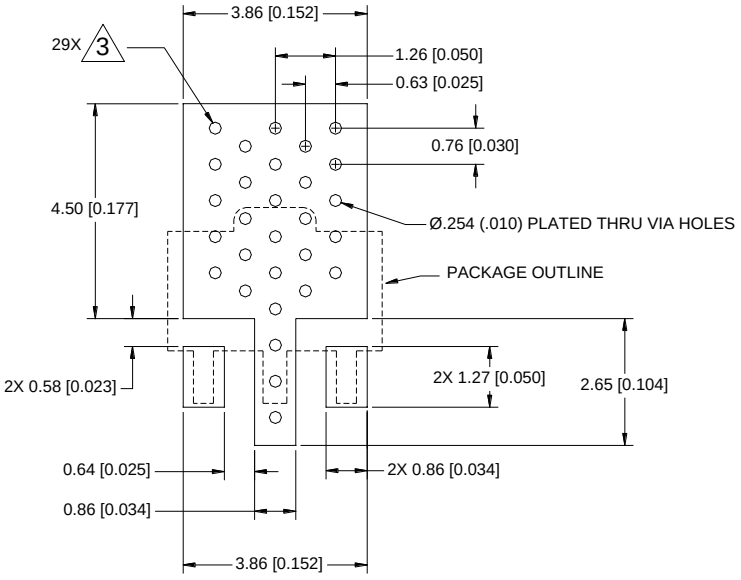


SYMBOL	MIN	NOM	MAX
A	1.40 (.055)	1.50 (.059)	1.60 (.063)
B	.44 (.017)	.50 (.020)	.56 (.022)
B1	.36 (.014)	.42 (.0165)	.48 (.019)
C	.35 (.014)	.40 (.016)	.44 (.017)
D	4.40 (.173)	4.50 (.177)	4.60 (.181)
D1	1.62 (.064)	1.73 (.068)	1.83 (.072)

SYMBOL	MIN	NOM	MAX
E	2.29 (.090)	2.50 (.098)	2.60 (.102)
E1	2.13 (.084)	2.20 (.087)	2.29 (.090)
e		1.50 BSC (.059)	
e1		3.00 BSC (.118)	
H	3.94 (.155)	4.10 (.161)	4.25 (.167)
L	.89 (.035)	1.10 (.043)	1.20 (.047)
M	2.2 (.087)	2.40 (.095)	2.6 (.102)

PCB Mounting Pattern

All dimensions are in millimeters (inches). Angles are in degrees.



NOTES:

1. All dimensions are in millimeters[inches]. Angles are in degrees.
2. Use 1 oz. copper minimum for top and bottom layer metal.
3. Vias are required under the backside paddle of this device for proper RF/DC grounding and thermal dissipation. We recommend a 0.35mm (#80/.0135") diameter bit for drilling via holes and a final plated thru diameter of 0.25mm (0.10").
4. Ensure good package backside paddle solder attach for reliable operation and best electrical performance.

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Product Compliance Information

ESD Information

Caution! ESD-Sensitive Device

ESD Rating:	Class 2
Value:	Passes ≥ 2000 V to < 4000 V
Test:	Human Body Model (HBM)
Standard:	JEDEC Standard JESD22-A114

ESD Rating:	Class IV
Value:	Passes ≥ 1000 V
Test:	Charged Device Model (CDM)
Standard:	JEDEC Standard JESD22-C101

MSL Rating

Moisture Sensitivity Level 1 at 260°C per JEDEC standard IPC/JEDEC J-STD-020.

Solderability

Package lead plating: NiPdAu

Compatible with both lead-free (260 °C max. reflow temp.) and tin/lead (245 °C max. reflow temp.) soldering processes.

RoHs Compliance

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A ($C_{15}H_{12}Br_4O_2$) Free
- PFOS Free
- SVHC Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about TriQuint:

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